Commercial Off-The-Shelf (COTS) for Higher Reliability Applications, X7R Dielectric, 6.3 – 250 VDC

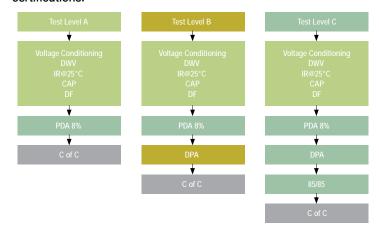


Overview

KEMET's COTS program is an extension of KEMET knowledge of high reliability test regimes and requirements. KEMET regularly supplies "up-screened" products by working with customer drawings and imposing specified design and test requirements. The COTS program offers the same high quality and high reliability components as up-screened products, but at a lower cost to the customer. This is accomplished by eliminating the need for customer-specific drawings to achieve the reliability level required for customer applications. A series of tests and inspections have been selected to provide the accelerated conditioning and 100% screening necessary to eliminate infant mortal failures from the population.

KEMET's X7R dielectric features a 125°C maximum operating temperature and is considered "temperature stable." The Electronics Components, Assemblies & Materials Association (EIA) characterizes X7R dielectric as a Class II material. Components of this classification are fixed, ceramic dielectric capacitors suited for bypass and decoupling applications or for frequency discriminating circuits where Q and stability of capacitance characteristics are not critical. X7R exhibits a predictable change in capacitance with respect to time and voltage and boasts a minimal change in capacitance with reference to ambient temperature. Capacitance change is limited to ±15% from -55°C to ±125°C.

All COTS testing includes voltage conditioning and post-electrical testing as per MIL-PRF-55681. For enhanced reliability, KEMET also provides the following test level options and conformance certifications:





Ordering Information

С	1210	Т	104	K	5	R	Α	С	TU
Ceramic	Case Size (L" x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Dielectric	Test Level	Termination Finish ¹	Packaging/ Grade (C-Spec)
	0402 0603 0805 1206 1210 1805 1808 1812 2220	T = COTS	Two significant digits and number of zeros	J = ±5% K = ±10% M = ±20%	9 = 6.3 8 = 10 4 = 16 3 = 25 5 = 50 1 = 100 2 = 200 A = 250	R = X7R	A = Testing per MIL- PRF-55681 PDA 8% B= Testing per MIL- PRF-55681 PDA 8%, DPA per EIA-469 C = Testing per MIL- PRF-55681 PDA 8%, DPA per EIA-469, Humidity per MIL-STD-202, Method 103, Condition A	C = 100% Matte Sn L = SnPb (5% Pb minimum) G = Gold (Au) 100 µin min.	See "Packaging C-Spec Ordering Options Table"

¹ Additional termination finish options may be available. Contact KEMET for details.



Benefits

- -55°C to +125°C operating temperature range
- · Lead (Pb)-free, RoHS and REACH compliant
- Voltage conditioning and post-electrical testing per MIL-PRF-55681
- Destructive Physical Analysis (DPA) per EIA-469
- Biased humidity testing (85/85) per MIL-STD-202
- · Certificate of Compliance
- Temperature stable dielectric
- EIA 0402, 0603, 0805, 1206, 1210, 1812, and 2220 case sizes

- DC voltage ratings of 6.3 V, 10 V, 16 V, 25 V, 50 V, 100 V, 200 V, and 250 V
- Capacitance offerings ranging from 10 pF to 22 μF
- Available capacitance tolerances of ±5%, ±10%, and ±20%
- · Non-polar device, minimizing installation concerns
- 100% pure matte tin-plated termination finish allowing for excellent solderability
- SnPb termination finish option available upon request (5% Pb minimum)

Applications

Typical applications include military, space quality and high reliability electronics.

Packaging C-Spec Ordering Options Table (100% Matte Sn and SnPb Terminations)

Packaging Type ¹	Packaging/Grade Ordering Code (C-Spec)
Bulk Bag/Unmarked	Not required (Blank)
7" Reel/Unmarked	TU
13" Reel/Unmarked	7138

¹ Default packaging is "Bulk Bag". An ordering code C-Spec is not required for "Bulk Bag" packaging.

¹ The terms "Marked" and "Unmarked" pertain to laser marking option of capacitors. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked. The option to laser mark is not available on these devices. For more information see "Capacitor Marking".



Packaging C-Spec Ordering Options Table (Gold Termination)

Termination Finish Options	Packaging Type/Options	Packaging Ordering Code (C-Spec)
	Standard Packaging – Unmarked ³	
	Bulk Bag	Blank ¹
	Waffle Tray ²	7292
	7" Reel	TU
	13" Reel	7138
G = Gold (Au) 100 μin minimum	7" Tape & Reel - 50 pieces	T050
	7" Tape & Reel - 100 pieces	T100
	7" Tape & Reel – 250 pieces	T250
	7" Tape & Reel - 500 pieces	T500
	7" Tape & Reel - 1,000 pieces	T1K0

¹ Default packaging is "Bulk Bag". An ordering code C-Spec is not required for "Bulk Bag" packaging.

Additional reeling or packaging options may be available. Contact KEMET for details.

¹ "Bulk Bag" packaging option is not available for Gold (Au) termination finish options and case sizes larger than 2225 (5664 Metric).

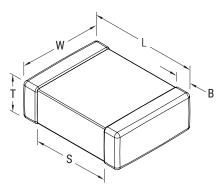
² "Waffle Tray" packaging option is not available for case sizes larger than 2225 (5664 Metric).

³ The terms "Marked" and "Unmarked" pertain to laser marking option of components. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked. The option to laser mark is not available on these devices.

³ Reeling quantities are dependent upon chip size and thickness dimension. When ordering using the "T1KO" packaging option, 1812 through 2225 case size devices with chip thickness of ≥ 1.9 mm (nominal) may be shipped on multiple 7" reels or a single 13" reel. Additional reeling or packaging options may be available. Contact KEMET for details.



Dimensions - Millimeters (Inches)



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0402	1005	1.00 (0.040) ±0.05 (0.002)	0.50 (0.020) ±0.05 (0.002)		0.30 (0.012) ±0.10 (0.004)	0.30 (0.012)	Solder Reflow Only
0603	1608	1.60 (0.063) ±0.15 (0.006)	0.80 (0.032) ±0.15 (0.006)		0.35 (0.014) ±0.15 (0.006)	0.50 (0.020)	
0805	2012	2.00 (0.079) ±0.20 (0.008)	1.25 (0.049) ±0.20 (0.008)		0.50 (0.02) ±0.25 (0.010)	0.70 (0.028)	Solder Wave or Solder Reflow
1206	3216	3.20 (0.126) ±0.20 (0.008)	1.60 (0.063) ±0.20 (0.008)		0.50 (0.02) ±0.25 (0.010)	1.50 (0.060)	
1210¹	3225	3.20 (0.126) ±0.20 (0.008)	2.50 (0.098) ±0.20 (0.008)	See Table 2 for Thickness	0.50 (0.02) ±0.25 (0.010)	1.50 (0.060)	
1805	4513	4.50 (0.177) ±0.50 (0.020)	1.27 (0.050) ±0.38 (0.015)		0.60 (0.024) ±0.35 (0.014)	2.90 (0.114)	
1808	4520	4.70 (0.185) ±0.50 (0.020)	2.00 (0.079) ±0.20 (0.008)		0.60 (0.024) ±0.35 (0.014)	2.90 (0.114)	Solder Reflow Only
1812	4532	4.50 (0.177) ±0.30 (0.012)	3.20 (0.126) ±0.30 (0.012)		0.60 (0.024) ±0.35 (0.014)	2.30 (0.091)	
2220	5650	5.70 (0.224) ±0.40 (0.016)	5.00 (0.197) ±0.40 (0.016)	1	0.60 (0.024) ±0.35 (0.014)	3.50 (0.138)	

¹ For capacitance values ≥ 4.7 μF add 0.02 (0.001) to the width tolerance dimension and 0.10 (0.004) to the length tolerance dimension.

Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

Environmental Compliance

Lead (Pb)-free, RoHS, and REACH compliant without exemptions (excluding SnPb termination finish option).



Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 Vdc Applied (TCC)	±15%
¹ Aging Rate (Maximum % Capacitance Loss/Decade Hour)	3.0%
² Dielectric Withstanding Voltage (DWV)	250% of rated voltage (5±1 seconds and charge/discharge not exceeding 50mA)
³ Dissipation Factor (DF) Maximum Limit at 25°C	5%(6.3V & 10V), 3.5%(16V & 25V) and 2.5%(50V to 250V)
⁴ Insulation Resistance (IR) Minimum Limit at 25°C	See Insulation Resistance Limit Table (Rated voltage applied for 120±5 seconds at 25°C)

¹ Regarding Aging Rate: Capacitance measurements (including tolerance) are indexed to a referee time of 1,000 hours.

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 & Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON".

Post Environmental Limits

	High Temperatu	ıre Life, Biased	l Humidity, Moist	ture Resistance	
Dielectric	Rated DC Voltage	Capacitance Value	Dissipation Factor (Maximum %)	Capacitance Shift	Insulation Resistance
	> 25		3.0		100/ - { :+:-
X7R	16/25	All	5.0	±20%	10% of Initial Limit
	< 16		7.5		Lillit

Insulation Resistance Limit Table

EIA Case Size	1,000 Megohm Microfarads or 100 GΩ	500 Megohm Microfarads or 10 GΩ
0201	N/A	ALL
0402	< 0.012 μF	≥ 0.012 µF
0603	< 0.047 μF	≥ 0.047 µF
0805	< 0.15 μF	≥ 0.15 µF
1206	< 0.47 μF	≥ 0.47 µF
1210	< 0.39 μF	≥ 0.39 µF
1805	ALL	N/A
1808	ALL	N/A
1812	< 2.2 μF	≥ 2.2 µF
1825	ALL	N/A
2220	< 10 μF	≥ 10 µF
2225	ALL	N/A

² DWV is the voltage a capacitor can withstand (survive) for a short period of time. It exceeds the nominal and continuous working voltage of the capacitor.

 $^{^3}$ Capacitance and dissipation factor (DF) measured under the following conditions: 1kHz ± 50Hz and 1.0 ± 0.2 Vrms if capacitance ≤10 μ F 120Hz ± 10Hz and 0.5 ± 0.1 Vrms if capacitance >10 μ F

⁴ To obtain IR limit, divide M Ω -μF value by the capacitance and compare to G Ω limit. Select the lower of the two limits.



Table 1A - Capacitance Range/Selection Waterfall (0402 - 1206 Case Sizes)

			se Si Serie			CO	40:	2C				CO	603	3C					C	803	050						(C12	060	2		
Capacitance	Cap	Vol	tage C	ode	9	8	4	3	5	9	8	4	3	5	1	2	9	8	4	3	5	1	2	A	9	8	4	3	5	1	2	A
	Code	Rate	ed Vol (VDC)	•	6.3	2	2	25	20	6.3	2	16	25	20	100	200	6.3	2	9	25	20	100	200	250	6.3	2	9	25	20	5	200	250
			acita Ieran																l Chi hick													
10 - 91 pF*	100 - 910*	J	K	М	ВВ	ВВ	BB	BB	BB	CF	DN	DN		DN	DN	DN	DN		EB													
	101 - 151**	J	K	M	BB	BB	BB	BB	BB	CF	DN	DN		DN	DN	DN	DN	DN	EB													
180 – 820 pF** 1,000 pF	181 – 821** 102	J	K	M M	BB BB	BB BB	BB BB	BB BB	BB BB	CF CF	DN DN	DN DN		DN DN	DN DN	DN DN	DN DN	DN DN	EB EB	EB												
1,200 pF	122	J	K	M	BB	BB	BB	BB	BB	CF	DN	DN		DN	DN	DN	DN	DN	EB													
1,500 pF	152	J	K	М	ВВ	ВВ	ВВ	BB	BB	CF	DN	DN		DN	DN	DN	DN	DN	EB													
1,800 pF	182	J	K	М	ВВ	ВВ	ВВ	ВВ	ВВ	CF	DN	DN	DN	DN	DN	DN	DN	DN	EB													
2,200 pF	222	J	K	М	ВВ	BB	BB	BB	BB	CF	DN	DN	DN	DN	DN	DN	DN	DN	EB													
2,700 pF	272	J	K	М	BB	BB	BB	BB	BB	CF	DN	DN		DN	DN	DN	DN	DN	EB													
3,300 pF	332	J	K	M	BB	BB	BB	BB	BB	CF	DN	DN		DN	DN	DN	DN	DN	EB													
3,900 pF	392 472	J	K	M M	BB BB	BB BB	BB BB	BB BB	BB BB	CF CF	DN DN	DN DN		DN DN	DN DN	DN DN	DN DN	DN DN	EB EB													
4,700 pF 5,600 pF	472 562	J	K	M	BB	BB	BB	BB	BB	CF	DN	DN		DN	DN	DN	DN	DN	EB													
6,800 pF	682	J	K	M	BB	BB	BB	BB	BB	CF	DN	DN		DN	DN	DN	DN	DN	EB													
8,200 pF	822	Ĵ	K	M	BB	BB	BB	BB	BB	CF	DN	DN		DN	DN	DN	DN	DN	EB													
10,000 pF	103	J	K	М	ВВ	ВВ	ВВ	BB	ВВ	CF	DN	DN	DN	DN	DN	DN	DN	DN	EB													
12,000 pF	123	J	K	М	ВВ	BB	BB	BB	BB	CF	CF	CF	CF	CF	CF		DN	DN	DN	DN	DN	DN	DN	DN	EB							
15,000 pF	153	J	K	М	ВВ	BB	BB	BB	BB	CF	CF	CF	CF	CF	CF		DN	DN		DN	DN	DP	DN	DN	EB							
18,000 pF	183	J	K	M	BB	BB	BB	BB	BB	CF	CF	CF	CF	CF	CF		DN	DN		DN	DN	DP	DN	DN	EB							
22,000 pF	223 273	J	K	M	BB	BB	BB BB	BB BB	BB	CF	CF CF	CF CF	CF	CF	CF CF		DN	DN		DN	DN	DP	DN	DN	EB EB	EB EB	EB	EB	EB	EB	EB	EB EB
27,000 pF 33,000 pF	333	J	K	M M	BB BB	BB BB	BB	BB		CF CF	CF	CF	CF CF	CF CF	CF		DN DN	DN DN		DN DN	DN DN	DP DP	DE DE		EB	EB	EB EB	EB EB	EB EB	EB EB	EB EB	EB
39,000 pF	393	J	K	M	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF		DN	DN		DN	DN	DP	DE		EB	EB	EB	EB	EB	EC	EB	EB
47,000 pF	473	Ĵ	K	M	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF		DN	DN		DN	DN	DE.	DG		EB	EB	EB	EB	EB	EC	ED	ED
56,000 pF	563	J	K	М	ВВ	ВВ	ВВ			CF	CF	CF	CF	CF			DP	DP	DP	DP	DP	DE	DG		EB	EB	EB	EB	EB	EB	ED	ED
68,000 pF	683	J	K	М	ВВ	ВВ	BB			CF	CF	CF	CF	CF			DP	DP	DP	DP	DP	DE			EB	EB	EB	EB	EB	EB	ED	ED
82,000 pF	823	J	K	М	ВВ	BB	BB			CF	CF	CF	CF	CF			DP	DP	DP	DP	DP	DE			EB	EB	EB	EB	EB	EB	ED	ED
0.10 μF	104	J	K	M	BB	ВВ	BB			CF	CF	CF	CF	CF			DN	DN		DN	DN	DE			EB	EB	EB	EB	EB	EB	EM	EM
0.12 µF	124 154	J	K	M						CF CF	CF CF	CF CF	CF CF	CF CF			DN	DN DN		DN DN	DP DP	DG DG			EC EC	EC EC	EC EC	EC EC	EC EC	EC EC	EG EG	
0.15 μF 0.18 μF	184	J	K	M						CF	CF	CF	CF	UF			DN DN	DN		DN	DP	DG			EC	EC	EC	EC	EC	EC	EG	
0.10 μF	224	J	K	M						CF	CF	CF	CF				DN	DN		DN	DP	DG			EC	EC	EC	EC	EC	EC		
0.27 μF	274	J	K	M	l					CF	CF	CF	0.				DP	DP	DP	DP	DP				EB	EB	EB	EB	EC	EM		
0.33 μF	334	J	K	М	İ					CF	CF	CF					DP	DP	DP	DP	DP				EB	EB	EB	EB	EC	EG		
0.39 µF	394	J	K	М	l					CF	CF	CF					DG	DG	DG	DG	DE				EB	EB	EB	EB	EC	EG		
0.47 μF	474	J	K	М						CF	CF	CF					DP	DP	DP	DP	DE				EC	EC	EC	EC	EC	EG		
0.56 μF	564	J	K	M													DP	DP	DP	DG	DH				ED	ED	ED	ED	EC			
0.68 µF	684	J	K	M													DP	DP	DP	DG	DH				EE EF	EE EF	EE	EE	ED ED			
0.82 μF 1 0 μF	824 105	J	K	M													DP np	DP	DP	DG							EF	EF EG				
1.0 μF 1.2 μF	105 125	J	K	M													DP DE		DP DE	טע					EF ED	EF ED	EF ED	EG	ED			
1.5 μF	155	J	K	M													DG		DG						EF	EF		EG				
1.8 µF	185	Ĵ	K	M													DG		DG						ED	ED		EF				
2.2 μF	225	J	K	М													DG		DG						ED	ED	ED	EF				
2.7 µF	275	J	K	М																					EN	EN		EH				
3.3 µF	335	J	K	M																					ED	ED	1	EH				
3.9 μF	395	J	K	M																					EF	EF		EH				
4.7 μF 5.6 μF	475 565	J	K	M																					EF EH	EF	EH	EH				
5.6 μF 6.8 μF	685	J J	K	M																					EH		EH					
υ.υ μι	000	D			\vdash										-	-						-	-	_						_	-	_
	Can	Kat	ed Vol (VDC)		6.3	2	16	25	20	6.3	2	16	25	20	100	200	6.3	2	16	25	20	100	200	250	6.3	2	16	25	20	5	200	250
Capacitance	Dacitance Cap Code Voltage Code 9 8 4 3		5	9	8	4	3	5	1	2	9	8	4	3	5	1	2	A	9	8	4	3	5	1	2	Α						
	Case Size/ C0402C							C	0603	C						C08	05C							C12	06C							
			Serie:	S	00.020																											

^{*}Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91)

^{**}Capacitance range Includes E12 decade values only. (i.e., 10, 12, 15, 18, 22, 27, 33, 39, 47, 56, 68, and 82)



Table 1A - Capacitance Range/Selection Waterfall (0402 - 1206 Case Sizes) cont.

		Case Size/ Series		CO	40:	2C				C0	603	3C					C	:08	050	C					C	12	060	;		
Capacitance 8.2 µF 10 µF	Cap	Voltage Code	9	8	4	3	5	9	8	4	3	5	1	2	9	8	4	3	5	1	2	Α	9	8	4	3	5	1	2	Α
	Code	Rated Voltage (VDC)	6.3	10	16	25	20	6.3	10	16	25	20	100	200	6.3	10	16	25	20	100	200	250	6.3	10	16	25	20	100	200	250
		Capacitance Tolerance									Pro	oduc See 1	t Av Table	aila e 2 f	bility or Cl	and nip T	l Chi hick	p Th	ickr s Dir	iess nens	Cod	es								
· ·	825 106	J K M J K M																					EH EH							
	Сар	Rated Voltage (VDC)	6.3	10	16	25	20	6.3	10	16	25	20	100	200	6.3	10	16	25	50	100	200	250	6.3	10	16	25	50	100	200	250
Capacitance	Code	Voltage Code	9	8	4	3	5	9	8	4	3	5	1	2	9	8	4	3	5	1	2	Α	9	8	4	3	5	1	2	Α
		Case Size/ Series		C	0402	2C				C	0603	C				,		C08	05C							C12	06C			

^{*}Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91)

Table 1B - Capacitance Range/Selection Waterfall (1210 - 1808 Case Sizes)

			e Siz eries	e/				C12	10C				C	1805	С	C	1808	C
Capacitance	Cap	Volt	age Cod	le	9	8	4	3	5	1	2	A	5	1	2	5	1	2
Capacitance	Code	Rated V	oltage (VDC)	6.3	10	16	25	20	100	200	250	20	100	200	20	100	200
		Capacita	pacitance Tolerance						ee Tab					ess Co nensior				
10 - 91 pF*	100 - 910*	J	K	М	FB	FB	FB	FB	FB	FB	FB							
100 -180 pF**	101 - 181**	J	K	M	FB	FB	FB	FB	FB	FB	FB							
220 pF	221	J	K	M	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC			
270 pF	271	J	K	M	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC			
330 pF	331	J	K	M	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC	LF	LF	LF
390 pF	391	J	K	M	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC	LF	LF	LF
470 - 820 pF**	471 - 821**	J	K	M	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC	LF	LF	LF
1,000 pF	102	J	K	M	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC	LF	LF	LF
1,200 pF	122	J	K	M	FB	FB	FB	FB	FB	FB	FB		NC	NC		LF	LF	LF
1,500 pF	152	J	K	M	FB	FB	FB	FB	FB	FB	FE		NC	NC		LF	LF	LF
1,800 pF	182	J	K	M	FB	FB	FB	FB	FB	FB	FE		NC	NC		LF	LF	LF
2,200 pF	222	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NC	NC		LF	LF	LF
2,700 pF	272	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA			LF	LF	LF
3,300 pF	332	J	K	М	FB	FB	FB	FB	FB	FB	FB	FB	NA			LF	LF	
3,900 pF	392	J	K	М	FB	FB	FB	FB	FB	FB	FB	FB	NA			LF	LF	
4,700 pF	472	J	К	М	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	
5,600 pF	562	j	К	М	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	
6,800 pF	682	j	К	М	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	
8,200 pF	822	Ĵ	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	
10,000 pF	103	Ĵ	K	М	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	
12,000 pF	123	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	
15,000 pF	153	Ĵ	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	
18,000 pF	183	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	
	Cap	Rated V	Rated Voltage (VDC)		2	91	25	20	100	200	250	20	100	200	20	100	200	
Capacitance	Cap Code	Volt	age Cod	le	9	8	4	3	5	1	2	A	5	1	2	5	1	2
		Case S	Case Size/Series					C12	10C					C18050			C18080	3

^{*}Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91)

^{**}Capacitance range Includes E12 decade values only. (i.e., 10, 12, 15, 18, 22, 27, 33, 39, 47, 56, 68, and 82)

^{**}Capacitance range Includes E12 decade values only. (i.e., 10, 12, 15, 18, 22, 27, 33, 39, 47, 56, 68, and 82)



Table 1B - Capacitance Range/Selection Waterfall (1210 - 2220 Case Sizes) cont.

			e Siz eries	e/				C12	10C				C	1805	C	C	1808	С
Capacitance	Cap	Volt	age Cod	le	9	8	4	3	5	1	2	A	5	1	2	5	1	2
oupuoitunoc	Code	Rated V	oltage (VDC)	6.3	10	16	25	20	100	200	250	50	100	200	50	100	200
		Capacita	nce Tol	erance				Pro S	duct A ee Tab	vailabi le 2 foi	ility and r Chip 1	d Chip Thickne	Thickn ess Din	ess Co nensior	des 1s			
22,000 pF	223	J	K	М	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	
27,000 pF	273	J	K	М	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	
33,000 pF	333	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA			LD	LD	
39,000 pF	393	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA			LD	LD	
47,000 pF	473	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA			LD	LD	
56,000 pF	563	J	K	M	FB	FB	FB	FB	FB	FB	FC	FC	NA			LD	LD	
68,000 pF	683	J	K	M	FB	FB	FB	FB	FB	FB	FC	FC	NA			LD		
82,000 pF	823	J	K	М	FB	FB	FB	FB	FB	FC	FF	FF	NA			LD		
0.10 μF	104	J	K	М	FB	FB	FB	FB	FB	FD	FG	FG	NA			LD		
0.12 μF	124	J	K	M	FB	FB	FB	FB	FB	FD	FH	FH				LD		
0.15 μF	154	J	K	M	FC	FC	FC	FC	FC	FD	FM	FM				LD		
0.18 μF	184	J	K	M	FC	FC	FC	FC	FC	FD	FK	FK				LD		
0.22 μF	224	J	K	M	FC	FC	FC	FC	FC	FD	FK	FK						
0.27 μF	274	J	K	M	FC	FC	FC	FC	FC	FD								
0.33 μF	334	J	K	M	FD	FD	FD	FD	FD	FD								
0.39 μF	394	J	K	M	FD	FD	FD	FD	FD	FD								
0.47 μF	474	J	K	M	FD	FD	FD	FD	FD	FD								
0.56 μF	564	J	K	M	FD	FD	FD	FD	FD	FF								
0.68 μF	684	J	K	M	FD	FD	FD	FD	FD	FG								
0.82 μF	824	J	K	M	FF	FF	FF	FF	FF	FL								
1.0 μF	105	J	K	M	FH	FH	FH	FH	FH	FM								
1.2 μF	125	J	K	M	FH	FH	FH	FH	FG									
1.5 μF	155	J	K	M	FH	FH	FH	FH	FG									
1.8 μF	185	J	K	M	FH	FH	FH	FH	FG									
2.2 μF	225	J	K	M	FJ	FJ	FJ	FJ	FG									
2.7 μF	275	J	K	M	FE	FE	FE	FG	FH									
3.3 μF	335	J	K	M	FF	FF	FF	FM	FM									
3.9 μF	395	J	K	M	FG	FG	FG	FG	FK									
4.7 μF	475	J	K	М	FC	FC	FC	FG	FS									
5.6 μF	565	J	K	M	FF	FF	FF	FH										
6.8 μF	685	J	K	M	FG	FG	FG	FM										
8.2 μF	825	J	K	M	FH	FH	FH	FK										
10 μF	106	J	K	М	FH	FH	FH	FS										
22 μF	226	J	K	M	FS	FS				<u> </u>				<u> </u>	<u> </u>	<u> </u>		
		Rated V	oltage (VDC)	6.3	2	92	25	20	90	200	250	20	100	200	20	100	200
Capacitance	Cap Code	Volt	age Cod	le	9	8	4	3	5	1	2	A	5	1	2	5	1	2
		Case S	Size/Se			C12	10C					C18050			C18080	•		

^{*}Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91)

^{**}Capacitance range Includes E12 decade values only. (i.e., 10, 12, 15, 18, 22, 27, 33, 39, 47, 56, 68, and 82)



Table 1C - Capacitance Range/Selection Waterfall (1812 - 2220 Case Sizes)

			e Siz	e/		C	:1812	С			C18	25C			C	2220	C	
Capacitance	Cap	Volt	age Cod	le	3	5	1	2	Α	5	1	2	Α	3	5	1	2	Α
Capacitance	Code	Rated V	oltage (VDC)	25	20	100	200	250	20	100	200	250	25	20	100	200	250
		Capacita	nce Tol	erance														
470 - 820 pF** 1,000 pF 1,200 pF 1,500 pF 1,800 pF 2,200 pF 2,700 pF 3,300 pF 3,900 pF 4,700 pF 5,600 pF 6,800 pF 10,000 pF 12,000 pF 12,000 pF 12,000 pF 22,000 pF 22,000 pF 27,000 pF 33,000 pF 39,000 pF 47,000 pF 39,000 pF 47,000 pF 56,000 pF 68,000 pF 68,000 pF 68,000 pF 0.10 μF 0.12 μF 0.15 μF 0.18 μF 0.22 μF 0.27 μF 0.33 μF	471 - 821** 102 122 152 182 222 272 332 392 472 562 682 822 103 123 153 183 223 273 333 393 473 563 683 823 104 124 154 184 224 274 334		K K K K K K K K K K K K K K K K K K K	M M M M M M M M M M M M M M M M M M M	GB G	GB GB GB GB GB GB GB GB GB GB GB GB GB G	GB GB GB GB GB GB GB GB GB GB GB GB GB G	GB GB GB GB GB GB GB GB GB GB GB GB GB G	GB GB GB GB GB GB GB GB GB GB GB GB GB G	НВ НВ НВ НВ НВ НВ НВ НВ НВ НВ	HB HB HB HB HB HB HB HB	HB HB HB HB HB HB HB HB	HB HB HB HB HB HB HB HB	JE JE JE JB JB JB JB JB JC JC JC	JE JE JE JE JB JB JB JB JB JC JC	JE J	10 10 10 10 10 10	10 10 10 10 10 10
0.39 µF 0.47 µF 0.56 µF 0.68 µF 0.82 µF 1.0 µF 1.2 µF 1.5 µF 1.8 µF 2.2 µF 3.9 µF 4.7 µF 10 µF 15 µF 22 µF	394 474 564 684 824 105 125 155 185 225 395 475 106 156 226]]]]]]	K K K K K K K K K K	M M M M M M M M M M M	GB GB GC GC GE GE GK GK GK	GB GB GC GC GE GE GE	GG GG GG GG GG	GG GJ	GG	HD HD HD HF HF	HD HD HD HF HF	HD HD HD HF HF	HD HD HD HF HF	JC JC JC JC JC JC JC JC JC JC JC JC JC J	JC JD JD JF JF JC JC JD JF JC JD JF JF JO	JC JC JD JD JF JF	JC JC JD JD JF JF	JC JC JD JD JF JF
	Con	Rated V	oltage (VDC)	25	20	9	200	250	20	100	200	250	25	20	100	200	250
Capacitance	Cap Code	Volt	age Cod	le	3	5	1	2	A	5	1	2	A	3	5	1	2	A
		Case S	Size/Se	ries			C18120	; 			C18	25C				C2220	C	

^{*}Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91)

^{**}Capacitance range Includes E12 decade values only. (i.e., 10, 12, 15, 18, 22, 27, 33, 39, 47, 56, 68, and 82)



Table 2A - Chip Thickness/Tape & Reel Packaging Quantities

Thickness	Case	Thickness ±	Paper C	uantity	Plastic Quantity		
Code	Size	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel	
BB	0402	0.50 ± 0.05	10,000	50,000	0	0	
CF	0603	0.80 ± 0.07	4,000	15,000	0	0	
DN	0805	0.78 ± 0.10	4,000	15,000	0	0	
DP	0805	0.90 ± 0.10	4,000	15,000	0	0	
DE	0805	1.00 ± 0.10	0	0	2,500	10,000	
DG	0805	1.25 ± 0.15	0	0	2,500	10,000	
DH	0805	1.25 ± 0.20	0	0	2,500	10,000	
EB	1206	0.78 ± 0.10	0	0	4,000	10,000	
EC	1206	0.90 ± 0.10	0	0	4,000	10,000	
EN ED	1206 1206	0.95 ± 0.10	0	0	4,000	10,000	
EE	1206	1.00 ± 0.10 1.10 ± 0.10	0	0 0	2,500 2,500	10,000 10,000	
EF	1206	1.10 ± 0.10 1.20 ± 0.15	0	0	2,500	10,000	
EM	1206	1.25 ± 0.15	0	0	2,500	10,000	
EG	1206	1.60 ± 0.15	0	0	2,000	8,000	
EH	1206	1.60 ± 0.13	0	0	2,000	8,000	
FB	1210	0.78 ± 0.10	0	0	4,000	10,000	
FC	1210	0.90 ± 0.10	Ö	0	4,000	10,000	
FD	1210	0.95 ± 0.10	0	0	4,000	10,000	
FE	1210	1.00 ± 0.10	0	0	2,500	10,000	
FF	1210	1.10 ± 0.10	0	0	2,500	10,000	
FG	1210	1.25 ± 0.15	0	0	2,500	10,000	
FL	1210	1.40 ± 0.15	0	0	2,000	8,000	
FH	1210	1.55 ± 0.15	0	0	2,000	8,000	
FM	1210	1.70 ± 0.20	0	0	2,000	8,000	
FJ	1210	1.85 ± 0.20	0	0	2,000	8,000	
FK	1210	2.10 ± 0.20	0	0	2,000	8,000	
FS	1210	2.50 ± 0.30	0	0	1,000	4,000	
NA NO	1805	0.90 ± 0.10	0	0	4,000	10,000	
NC LD	1805 1808	1.00 ± 0.15 0.90 ± 0.10	0	0	4,000 2,500	10,000 10,000	
LF	1808	1.00 ± 0.15	0	0	2,500	10,000	
GB	1812	1.00 ± 0.13	0	0	1,000	4,000	
GC	1812	1.10 ± 0.10	0	0	1,000	4,000	
GD	1812	1.25 ± 0.15	0	0	1,000	4,000	
GE	1812	1.30 ± 0.10	0	0	1,000	4,000	
GH	1812	1.40 ± 0.15	0	0	1,000	4,000	
GG	1812	1.55 ± 0.10	0	0	1,000	4,000	
GK	1812	1.60 ± 0.20	0	0	1,000	4,000	
GJ	1812	1.70 ± 0.15	0	0	1,000	4,000	
GO	1812	2.50 ± 0.20	0	0	500	2,000	
HB	1825	1.10 ± 0.15	0	0	1,000	4,000	
HD	1825	1.30 ± 0.15	0	0	1,000	4,000	
HF	1825	1.50 ± 0.15	0	0	1,000	4,000	
JB JC	2220 2220	1.00 ± 0.15	0	0	1,000 1,000	4,000 4,000	
JD JD	2220	1.10 ± 0.15 1.30 ± 0.15	0	0	1,000	4,000	
JE	2220	1.40 ± 0.15	0	0	1,000	4,000	
JF	2220	1.50 ± 0.15	0	0	1,000	4,000	
JO	2220	2.40 ± 0.15	Ö	Ö	500	2,000	
Thickness	Case	Thickness ±	7" Reel	13" Reel	7" Reel	13" Reel	
Code	Size ¹	Range (mm)	Paper Q		Plastic (L Quantity	

Package quantity based on finished chip thickness specifications.



Table 2B - Bulk Packaging Quantities

Dookse	ing Type	Loose Packaging		
Раскас	jing Type	Bulk Bag	(default)	
Packagi	ng C-Spec ¹	N,	/A ²	
Cas	e Size	Packaging Quantities ((pieces/unit packaging)	
EIA (in)	Metric (mm)	Minimum	Maximum	
0402	1005			
0603	1608		50,000	
0805	2012			
1206	3216			
1210	3225	1		
1808	4520			
1812	4532			
1825	4564		20,000	
2220	5650			
2225	5664			

¹ The "Packaging C-Spec" is a 4 to 8 digit code which identifies the packaging type and/or product grade. When ordering, the proper code must be included in the 15th through 22nd character positions of the ordering code. See "Ordering Information" section of this document for further details. Commercial Grade product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging. Contact KEMET if you require a bulk bag packaging option for Automotive Grade products.

² A packaging C-Spec (see note 1 above) is not required for "Bulk Bag" packaging (excluding Anti-Static Bulk Bag and Automotive Grade products). The 15th through 22nd character positions of the ordering code should be left blank. All product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging.



Table 3 - Chip Capacitor Land Pattern Design Recommendations per IPC-7351

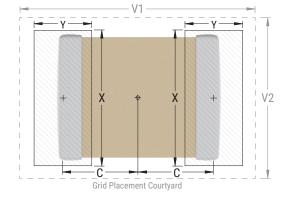
EIA Size Code	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)			ı	Density Level B: Median (Nominal) Land Protrusion (mm)			Density Level C: Minimum (Least) Land Protrusion (mm)							
Oode	Code	С	Y	Х	V1	V2	С	Y	X	V1	V2	С	Υ	X	V1	V2
0402	1005	0.50	0.72	0.72	2.20	1.20	0.45	0.62	0.62	1.90	1.00	0.40	0.52	0.52	1.60	0.80
0603	1608	0.90	1.15	1.10	4.00	2.10	0.80	0.95	1.00	3.10	1.50	0.60	0.75	0.90	2.40	1.20
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	0.95	1.35	2.80	1.70
1206	3216	1.60	1.35	1.90	5.60	2.90	1.50	1.15	1.80	4.70	2.30	1.40	0.95	1.70	4.00	2.00
1210	3225	1.60	1.35	2.80	5.65	3.80	1.50	1.15	2.70	4.70	3.20	1.40	0.95	2.60	4.00	2.90
1210¹	3225	1.50	1.60	2.90	5.60	3.90	1.40	1.40	2.80	4.70	3.30	1.30	1.20	2.70	4.00	3.00
1812	4532	2.15	1.60	3.60	6.90	4.60	2.05	1.40	3.50	6.00	4.00	1.95	1.20	3.40	5.30	3.70
2220	5650	2.75	1.70	5.50	8.20	6.50	2.65	1.50	5.40	7.30	5.90	2.55	1.30	5.30	6.60	5.60

¹ Only for capacitance values ≥ 22 μF

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805, and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).

Image below based on Density Level B for an EIA 1210 case size.





Soldering Process

Recommended Soldering Technique:

- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are limited to solder reflow only

Recommended Reflow Soldering Profile:

KEMET's families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Terminati	ion Finish	
1 Tome Teature	SnPb	100% Matte Sn	
Preheat/Soak			
Temperature Minimum (T _{Smin})	100°C	150°C	
Temperature Maximum (T _{Smax})	150°C	200°C	
Time (t_s) from T_{smin} to T_{smax}	60 - 120 seconds	60 - 120 seconds	
Ramp-Up Rate (T _L to T _p)	3°C/second maximum	3°C/second maximum	
Liquidous Temperature (T_L)	183°C	217°C	
Time Above Liquidous (t _L)	60 - 150 seconds	60 - 150 seconds	
Peak Temperature (T _P)	235°C	260°C	
Time Within 5°C of Maximum Peak Temperature (t _p)	20 seconds maximum	30 seconds maximum	
Ramp-Down Rate (T _p to T _L)	6°C/second maximum	6°C/second maximum	
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum	

Note 1: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly reflow.

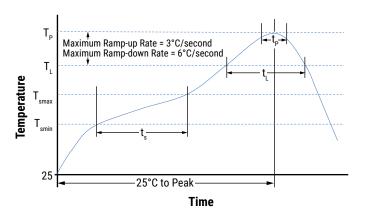




Table 4 - Performance & Reliability: Test Methods and Conditions

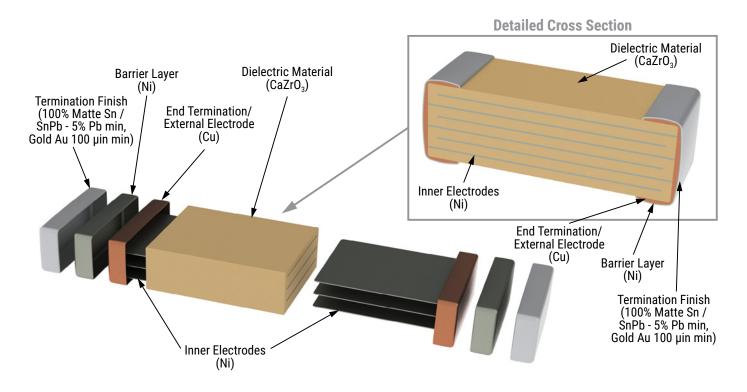
Stress	Reference	Test or Inspection Method
Terminal Strength	JIS-C-6429	Appendix 1, Note: Force of 1.8 kg for 60 seconds.
Board Flex	JIS-C-6429	Appendix 2, Note: Standard termination system – 2.0 mm (minimum) for all except 3 mm for COG. Flexible termination system – 3.0 mm (minimum).
		Magnification 50 X. Conditions:
Solderability	J-STD-002	a) Method B, 4 hours at 155°C, dry heat at 235°C
Solderability	J-31D-002	b) Method B at 215°C category 3
		c) Method D, category 3 at 260°C
Temperature Cycling	JESD22 Method JA-104	1,000 Cycles (-55°C to +125°C). Measurement at 24 hours +/-4 hours after test conclusion.
Biased Humidity	MIL-STD-202 Method 103	Load Humidity: 1,000 hours 85°C/85% RH and rated voltage. Add 100 K ohm resistor. Measurement at 24 hours +/-4 hours after test conclusion. Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor. Measurement at 24 hours +/-4 hours after test conclusion.
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Measurement at 24 hours +/-4 hours after test conclusion.
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Number of cycles required - 300, maximum transfer time - 20 seconds, dwell time - 15 minutes. Air - Air.
High Temperature Life	MIL-STD-202 Method 108/EIA-198	1,000 hours at 125°C (85°C for X5R, Z5U and Y5V) with 2 X rated voltage applied.
Storage Life	MIL-STD-202 Method 108	150°C, 0 VDC for 1,000 hours.
Vibration	MIL-STD-202 Method 204	5 g's for 20 min., 12 cycles each of 3 orientations. Note: Use 8" X 5" PCB 0.031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Condition F.
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemical, OKEM Clean or equivalent.

Storage & Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature—reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



Construction





Capacitor Marking (Optional)

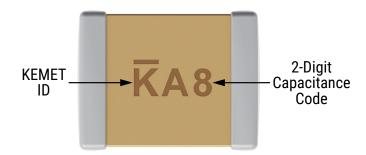
These surface mount multilayer ceramic capacitors are normally supplied unmarked. If required, they can be marked as an extra cost option. Marking is available on most KEMET devices, but must be requested using the correct ordering code identifier(s). If this option is requested, two sides of the ceramic body will be laser marked with a "K" to identify KEMET, followed by two characters (per EIA-198 - see table below) to identify the capacitance value. EIA 0603 case size devices are limited to the "K" character only.

Laser marking option is <u>not</u> available on:

- · COG, ultra stable X8R and Y5V dielectric devices.
- EIA 0402 case size devices.
- EIA 0603 case size devices with flexible termination option.
- KPS commercial and automotive grade stacked devices
- X7R dielectric products in capacitance values outlined below.

EIA Case Size	Metric Size Code	Capacitance
0603	1608	≤ 170 pF
0805	2012	≤ 150 pF
1206	3216	≤ 910 pF
1210	3225	≤ 2,000 pF
1808	4520	≤ 3,900 pF
1812	4532	≤ 6,700 pF
1825	4564	≤ 0.018 µF
2220	5650	≤ 0.027 µF
2225	5664	≤ 0.033 µF

Marking appears in legible contrast. Illustrated below is an example of an MLCC with laser marking of "KA8", which designates a KEMET device with rated capacitance of 100 μ F. Orientation of marking is vendor optional.





Capacitor Marking (Optional) cont.

	C	apacita	nce (p	F) For \	/arious	Alpha/	Numera	al Identif	iers			
A L. L.						Numera						
Alpha	9	0	1	2	3	4	5	6	7	8		
Character		Capacitance (pF)										
Α	0.10	1.0	10	100	1,000	10,000	100,000	1,000,000	10,000,000	100,000,000		
В	0.11	1.1	11	110	1,100	11,000	110,000	1,100,000	11,000,000	110,000,000		
С	0.12	1.2	12	120	1,200	12,000	120,000	1,200,000	12,000,000	120,000,000		
D	0.13	1.3	13	130	1,300	13,000	130,000	1,300,000	13,000,000	130,000,000		
E	0.15	1.5	15	150	1,500	15,000	150,000	1,500,000	15,000,000	150,000,000		
F	0.16	1.6	16	160	1,600	16,000	160,000	1,600,000	16,000,000	160,000,000		
G	0.18	1.8	18	180	1,800	18,000	180,000	1,800,000	18,000,000	180,000,000		
Н	0.20	2.0	20	200	2,000	20,000	200,000	2,000,000	20,000,000	200,000,000		
J	0.22	2.2	22	220	2,200	22,000	220,000	2,200,000	22,000,000	220,000,000		
К	0.24	2.4	24	240	2,400	24,000	240,000	2,400,000	24,000,000	240,000,000		
L	0.27	2.7	27	270	2,700	27,000	270,000	2,700,000	27,000,000	270,000,000		
М	0.30	3.0	30	300	3,000	30,000	300,000	3,000,000	30,000,000	300,000,000		
N	0.33	3.3	33	330	3,300	33,000	330,000	3,300,000	33,000,000	330,000,000		
Р	0.36	3.6	36	360	3,600	36,000	360,000	3,600,000	36,000,000	360,000,000		
Q	0.39	3.9	39	390	3,900	39,000	390,000	3,900,000	39,000,000	390,000,000		
R	0.43	4.3	43	430	4,300	43,000	430,000	4,300,000	43,000,000	430,000,000		
S	0.47	4.7	47	470	4,700	47,000	470,000	4,700,000	47,000,000	470,000,000		
Т	0.51	5.1	51	510	5,100	51,000	510,000	5,100,000	51,000,000	510,000,000		
U	0.56	5.6	56	560	5,600	56,000	560,000	5,600,000	56,000,000	560,000,000		
V	0.62	6.2	62	620	6,200	62,000	620,000	6,200,000	62,000,000	620,000,000		
W	0.68	6.8	68	680	6,800	68,000	680,000	6,800,000	68,000,000	680,000,000		
Х	0.75	7.5	75	750	7,500	75,000	750,000	7,500,000	75,000,000	750,000,000		
Υ	0.82	8.2	82	820	8,200	82,000	820,000	8,200,000	82,000,000	820,000,000		
Z	0.91	9.1	91	910	9,100	91,000	910,000	9,100,000	91,000,000	910,000,000		
а	0.25	2.5	25	250	2,500	25,000	250,000	2,500,000	25,000,000	250,000,000		
b	0.35	3.5	35	350	3,500	35,000	350,000	3,500,000	35,000,000	350,000,000		
d	0.40	4.0	40	400	4,000	40,000	400,000	4,000,000	40,000,000	400,000,000		
е	0.45	4.5	45	450	4,500	45,000	450,000	4,500,000	45,000,000	450,000,000		
f	0.50	5.0	50	500	5,000	50,000	500,000	5,000,000	50,000,000	500,000,000		
m	0.60	6.0	60	600	6,000	60,000	600,000	6,000,000	60,000,000	600,000,000		
n	0.70	7.0	70	700	7,000	70,000	700,000	7,000,000	70,000,000	700,000,000		
t	0.80	8.0	80	800	8,000	80,000	800,000	8,000,000	80,000,000	800,000,000		
у	0.90	9.0	90	900	9,000	90,000	900,000	9,000,000	90,000,000	900,000,000		



Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

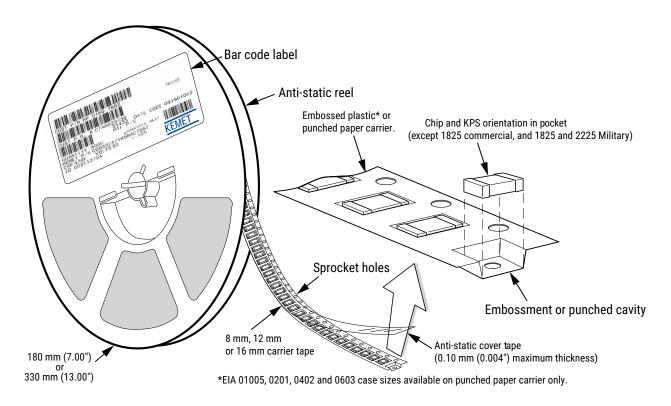


Table 5 - Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

	- 0	Embosse	ed Plastic	Punche	d Paper
EIA Case Size	Tape Size (W)*	7" Reel	13" Reel	7" Reel	13" Reel
	(**)	Pitch	Pitch (P₁)*		(P ₁)*
01005 - 0402	8			2	2
0603	8			4	4
0805	8	4	4	4	4
1206 - 1210	8	4	4	4	4
1805 – 1808	12	4	4		
≥ 1812	12	8	8		
KPS 1210	12	8	8		
KPS 1812 and 2220	16	12	12		
Array 0612	8	4	4		

^{*}Refer to Figures 1 and 2 for W and P_1 carrier tape reference locations.

^{*}Refer to Tables 6 and 7 for tolerance specifications.



Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

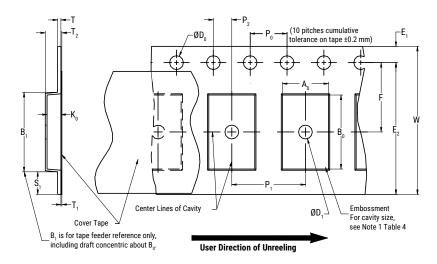


Table 6 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)									
Tape Size	D ₀	D ₁ Minimum Note 1	E ₁	P ₀	P ₂	R Reference Note 2	S ₁ Minimum Note 3	T Maximum	T ₁ Maximum	
8 mm		1.0 (0.039)				25.0 (0.984)				
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	30	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)	
16 mm		(0.059)	(0.059)				(1.181)			
		1	Variable Dime	ensions — Mill	limeters (Inch	nes)				
Tape Size	Pitch	B ₁ Maximum Note 4	E ₂ Minimum	F	P ₁	T ₂ Maximum	W Maximum	A ₀ ,B ₀	& K ₀	
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)			
12 mm	Single (4 mm) and double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Not	te 5	
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)			

- 1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of the embossment location and the hole location shall be applied independently of each other.
- 2. The tape with or without components shall pass around R without damage (see Figure 6.)
- 3. If $S_1 < 1.0$ mm, there may not be enough area for a cover tape to be properly applied (see EIA Standard 481, paragraph 4.3, section b.)
- 4. B_1 dimension is a reference dimension for tape feeder clearance only.
- 5. The cavity defined by A_{α} , B_{α} and K_{α} shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3.)
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4.)
 - (e) for KPS product, A_0 and B_0 are measured on a plane 0.3 mm above the bottom of the pocket.
 - (f) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.



Figure 2 - Punched (Paper) Carrier Tape Dimensions

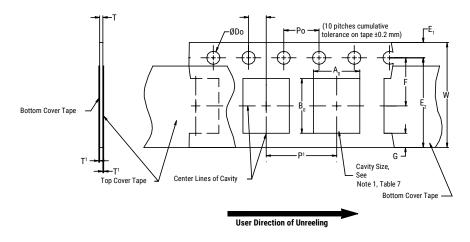


Table 7 - Punched (Paper) Carrier Tape Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)								
Tape Size	D ₀	E ₁	P ₀	P ₂	T ₁ Maximum	G Minimum	R Reference Note 2		
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) maximum	0.75 (0.030)	25 (0.984)		
		Variable D	imensions – M	illimeters (Inch	es)				
Tape Size	Pitch	E2 Minimum	F	P ₁	T Maximum	W Maximum	A_0B_0		
8 mm	Half (2 mm)	6.25	3.5 ±0.05	2.0 ±0.05 (0.079 ±0.002)	1.1	8.3 (0.327)	Note 1		
8 mm	Single (4 mm)	(0.246)	(0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	(0.098)	8.3 (0.327)	Note I		

- 1. The cavity defined by A_{n} , B_{n} and T shall surround the component with sufficient clearance that:
 - a) the component does not protrude beyond either surface of the carrier tape.
 - b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed
 - c) rotation of the component is limited to 20° maximum (see Figure 3.)
 - d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4.)
 - e) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.
- 2. The tape with or without components shall pass around R without damage (see Figure 6.)



Packaging Information Performance Notes

1. Cover Tape Break Force: 1.0 kg minimum.

2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 to 1.0 newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

Figure 3 – Maximum Component Rotation

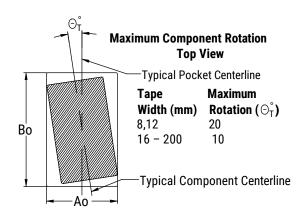


Figure 4 - Maximum Lateral Movement

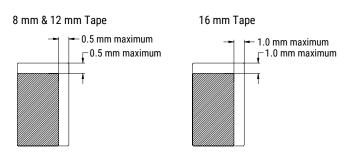


Figure 5 - Bending Radius

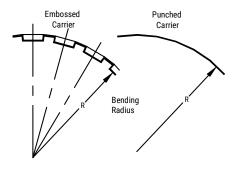
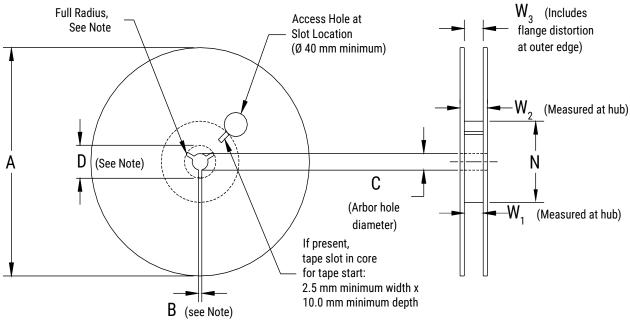




Figure 6 - Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 8 - Reel Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)									
Tape Size	A	B Minimum	С	D Minimum						
8 mm	178 ±0.20									
12 mm	(7.008 ±0.008) or	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)						
16 mm	330 ±0.20 (13.000 ±0.008)	, ,	,	, -,						
	Variable	Dimensions — Millimeter	rs (Inches)							
Tape Size	N Minimum	W ₁	W ₂ Maximum	W ₃						
8 mm		8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)							
12 mm	50 (1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference						
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)							



Figure 7 - Tape Leader & Trailer Dimensions

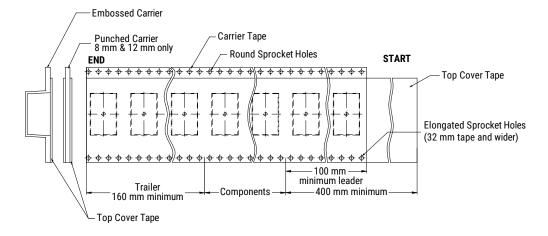
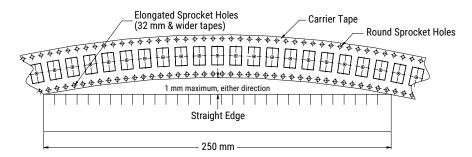


Figure 8 - Maximum Camber





KEMET Electronics Corporation Sales Offices

For a complete list of our global sales offices, please visit www.kemet.com/sales.

Disclaimer

YAGEO Corporation and its affiliates do not recommend the use of commercial or automotive grade products for high reliability applications or manned space flight.

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed. All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicated or that other measures may not be required.